

Press Release

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PROMEX INDUSTRIES ACQUIRES QUIK-PAK, A DIVISION OF DELPHON

SANTA CLARA, CA, APRIL 1 2015: Promex Industries, announced today the acquisition of San Diego based Quik-Pak, a division of Delphon. Quik-Pak will retain its San Diego, CA location and operate as a division of Promex. The combined entities are now able to offer a broader range of electronic and microelectronic assembly services.

"This is an exciting enhancement for Promex", says Richard Otte, Promex president, "We look forward to leveraging the strengths of the combined companies to provide customers with broader engineering expertise, enhanced packaging capabilities, expanded facilities, and superior customer service." Promex is in the heart of Silicon Valley and is known for the caliber of its engineering staff. Quik-Pak is in Southern California and recently expanded its packaging and assembly operation to include higher volume transfer molding and wafer processing capabilities. Together, the facilities

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are ISO 13485:2003 and ISO 9001:2008 certified, ITAR and FDA
Title 21 Part 820 compliant.

About Promex:

Promex operates a 30,000 square foot assembly facility with class 100 and 1000 clean rooms where it provides a broad range of assembly services to the medical, bioscience, commercial semiconductor and military markets. The company has a highly skilled engineering team, a broad range of assembly capabilities and is thus able to develop and provide mixed technology assembly processes that integrate conventional surface mount technology (SMT) with semiconductor microelectronic packaging and assembly methods (wafer sawing, flip-chip, complex die attach, wire bonding, overmolding, etc.) to support the complex, heterogeneous assembly needs of emerging markets.

About Quik-Pak:

Quik-Pak operates a 15,000 square foot facility from which it provides IC packaging and assembly services to the semiconductor, telecom, RF wireless, and medical markets. Quik-Pak offers both open-molded plastic packages and pre-molded plastic packages (OmPP) and recently expanded both of these product lines. Quik-Pak's OmPP plastic packages are cost-effective, come in standard sizes and lead counts, can be customized, and are ideal for prototype or production volume applications. Quik-Pak offers a variety of services that

together provide a full turn-key packaging and assembly solution including wafer preparation, die/wire bonding, encapsulation and marking/branding - all under one roof. Custom assembly services are also offered for Flip Chip, Ceramic Packages, Chip-on-Board, Stacked Die, MEMS, and other complex assemblies.